

January 2011 SupreMOS

FCH47N60NF 600V N-Channel MOSFET, FRFET

FCH47N60NF N-Channel MOSFET, FRFET 600V, 47A, 65mΩ

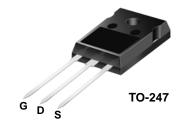
Features

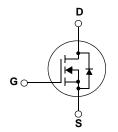
- $R_{DS(on)} = 57.5 m\Omega$ (Typ.) @ $V_{GS} = 10V$, $I_D = 23.5A$
- Ultra Low Gate Charge (Typ. Q_g = 121nC)
- Low Effective Output Capacitance
- 100% Avalanche Tested
- RoHS Compliant

Description

The SupreMOS MOSFET, Fairchild's next generation of high voltage super-junction MOSFETs, employs a deep trench filling process that differentiates it from preceding multi-epi based technologies. By utilizing this advanced technology and precise process control, SupreMOS provides world class Rsp, superior switching performance and ruggedness.

This SupreMOS MOSFET fits the industry's AC-DC SMPS requirements for PFC, server/telecom power, FPD TV power, ATX power, and industrial power applications.





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol		Parameter			
V _{DSS}	Drain to Source Voltage	600	V		
V _{GSS}	Gate to Source Voltage			±30	V
ID	Drain Current	-Continuous (T _C = 25 ^o C)		45.8	
		-Continuous (T _C = 100 ^o C)		28.9	Α
I _{DM}	Drain Current	- Pulsed	(Note 1)	137.4	Α
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		(Note 2)	2926	mJ
I _{AR}	Avalanche Current			15.3	А
E _{AR}	Repetitive Avalanche Energy			3.7	mJ
du /dt	MOSFET dv/dt Ruggednes		100	V/ns	
dv/dt	Peak Diode Recovery dv/d	t	(Note 3)	50	V/ns
P _D	Power Dissipation	$(T_{\rm C} = 25^{\rm o}{\rm C})$		368	W
		- Derate above 25°C		2.94	W/ºC
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C

Thermal Characteristics

Symbol	Parameter	Ratings	Units
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	0.34	
$R_{\theta CS}$	Thermal Resistance, Case to Heat Sink (Typical)	0.24	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	40	

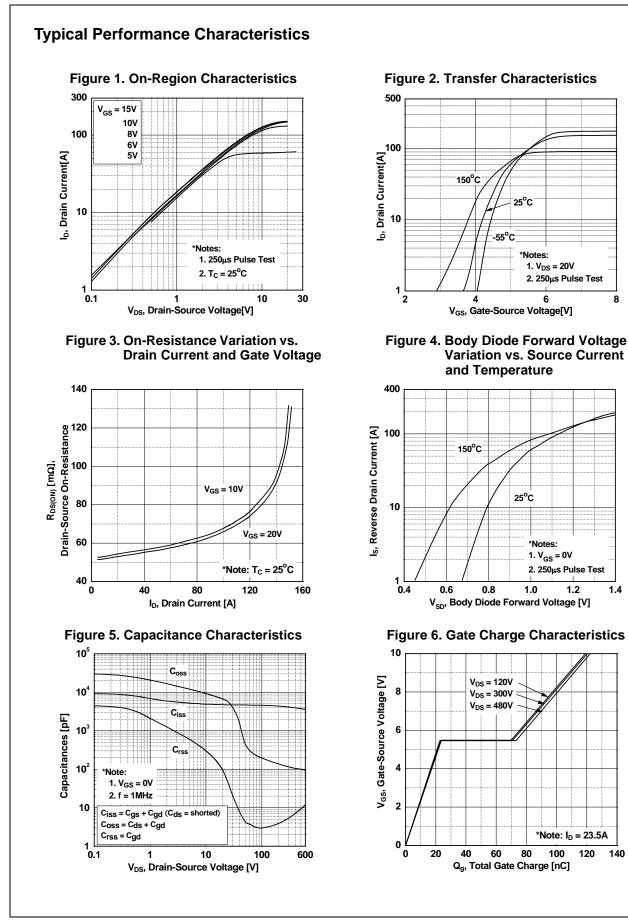
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		Device	Packag	Package Reel Size Ta		Тар	e Width		Quantity		
		TO-247	7	-		-		30			
Electrica	I Char	acteristics T _c =	25°C unless of	otherwis	e noted						
Symbol		Parameter			Test Conditions		Min.	Тур.	Max.	Units	
Off Charac	teristic	S									
BV _{DSS}	Drain to Source Breakdown Voltage		oltage	$I_{D} = 1 \text{mA}, V_{GS} = 0 \text{V}, T_{C} = 25^{\circ} \text{C}$		600	-	-	V		
ΔBV_{DSS}	Breakdo	akdown Voltage Temperature		$I_D = 1$ mA, Referenced to 25°C		-	0.78	-	V/ºC		
ΔT_{J}	Coefficient			V _{DS} = 480V, V _{GS} = 0V		_	_	10			
I _{DSS}	Zero Gate Voltage Drain Current		ent		180V, V _{GS} = 0V, T _C :	= 125°C	-	-	100	μA	
I _{GSS}	Gate to	ate to Body Leakage Current			±30V, V _{DS} = 0V	- 120 0	-	-	±100	nA	
On Charac	toristic	e .			20		I			1	
V _{GS(th)}		nreshold Voltage		$V_{CS} = $	V _{DS} , I _D = 250μA		3	-	5	V	
R _{DS(on)}		rain to Source On Res	istance		10V, I _D = 23.5A		-	57.5	65.0	mΩ	
9 _{FS}	Forward	d Transconductance			40V, I _D = 23.5A		-	52	100	S	
Dynamic C	haracte	eristics									
C _{iss}		apacitance	ance			-	4600	6120	pF		
C _{oss}	Output	ut Capacitance		V _{DS} = 100V, V _{GS} = 0V f = 1MHz		-	195	260	pF		
C _{rss}	Reverse	rse Transfer Capacitance				-	3.0	5.0	pF		
C _{oss}	Output	ut Capacitance		V _{DS} = 380V, V _{GS} = 0V, f = 1MHz		-	108	-	pF		
C _{oss} eff.	Effective	ve Output Capacitance		$V_{DS} = 0V \text{ to } 380V, V_{GS} = 0V$		-	492	-	pF		
Q _{q(tot)}	Total Ga	Gate Charge at 10V				-	121	157	nC		
Q _{gs}	Gate to	Source Gate Charge			V _{DS} = 380V, I _D = 23.5A,		-	23	-	nC	
Q _{gd}	Gate to			V _{GS} = 10V (Note 4)		-	47	-	nC		
ESR		quivalent Series Resistance(G-S)		Drain Open		-	0.9	-	Ω		
Switching	Charac	toristics	,		•						
		Delay Time					_	34	78	ns	
t _{d(on)} t		Rise Time		$V_{DD} = 380V, I_D = 23.5A$ $R_{GEN} = 4.7\Omega$ (Note 4)			-	22	54	ns	
t _r		f Delay Time					-	117	244	ns	
t _{d(off)} t _f		f Fall Time					-	4	18	ns	
	rce Dior	de Characteristic	6								
		m Continuous Drain to		Forwar	d Current		-	-	47	A	
I _{SM}	Maximu	m Pulsed Drain to Sou	rce Diode For			-	-	141	Α		
V _{SD}		Source Diode Forward		$V_{GS} = 0V, I_{SD} = 23.5A$		-	-	1.2	V		
t _{rr}	Reverse	Recovery Time		$V_{GS} = 0V, I_{SD} = 23.5A$		-	169	-	ns		
Q _{rr}	Reverse	Recovery Charge	$dl_{\rm F}/dt = 100 A/\mu s$			-	1.3	-	μC		
2. I _{AS} = 15.3A, R _G 3. I _{SD} ≤ 45.8 A, di/	= 25Ω, Starti dt ≤ 1200A/μs	h limited by maximum junction ng T _J = 25°C s, V _{DD} \leq 380V, Starting T _J = 29 perating Temperature Typical	5°C								

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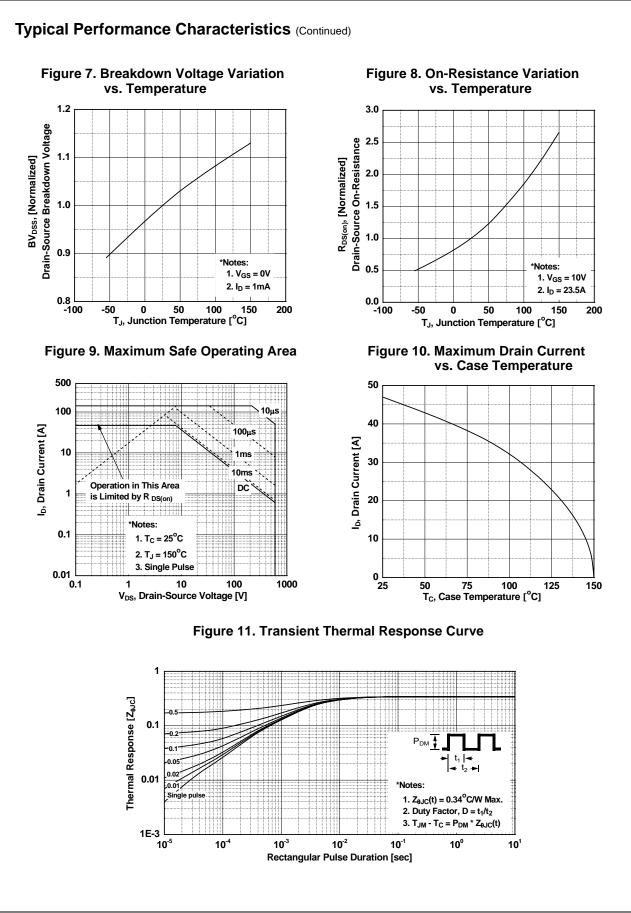
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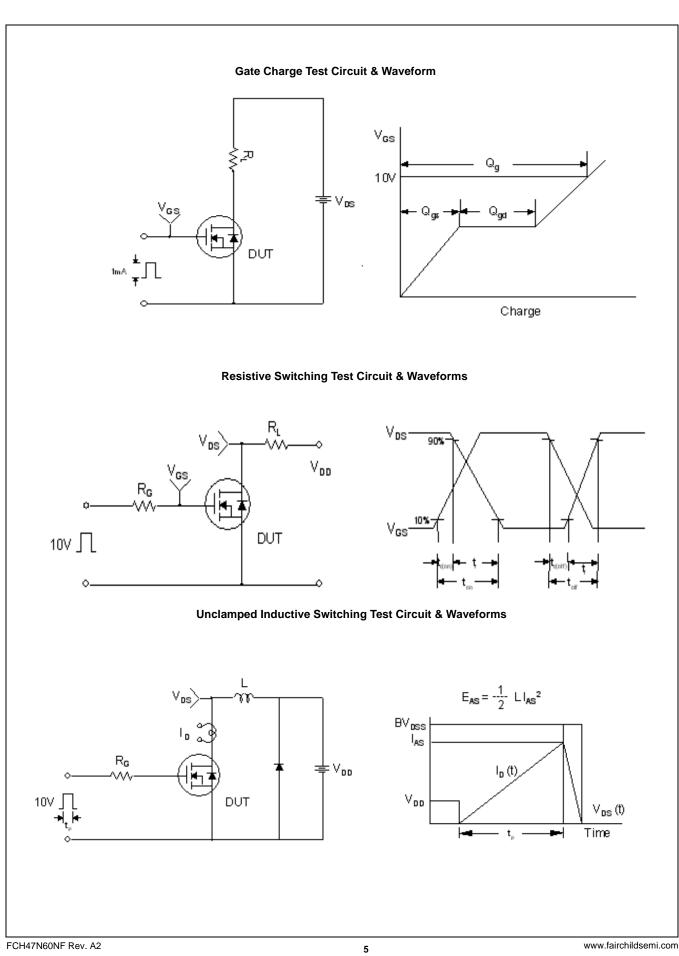
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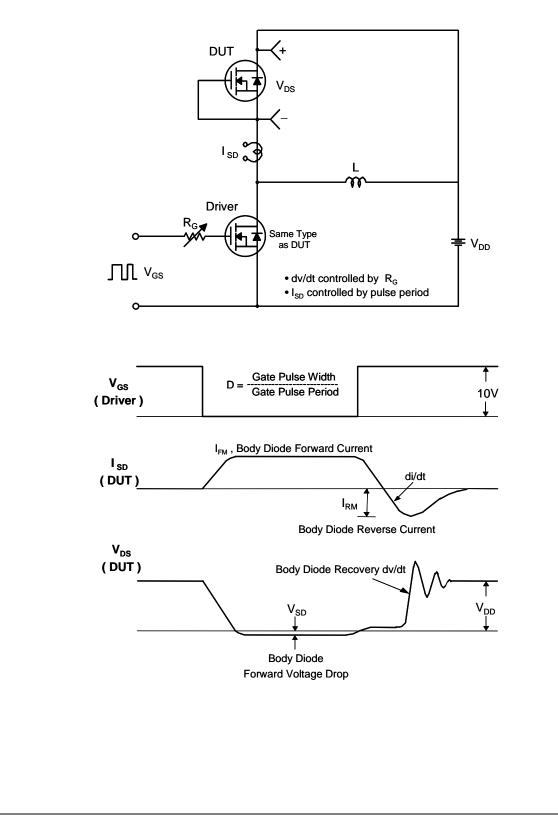
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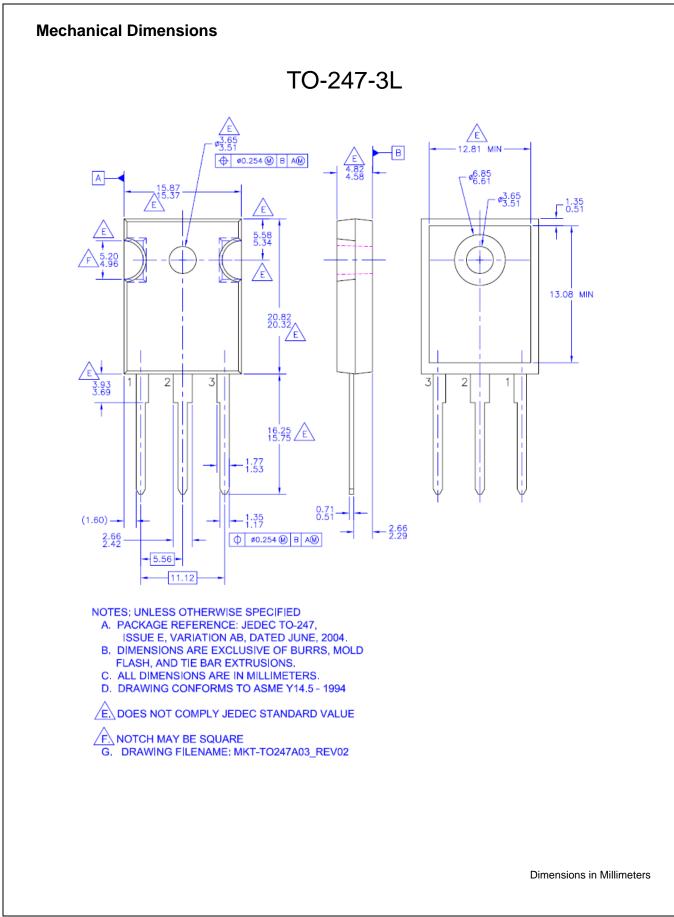


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